First Edition Sep 29, 2005

LCD Module Technical Specification

Final Revision

Type No.

T-51991GD015-MLW-AIN

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Table of Contents

General Specifications	2
2. Electrical Specifications	3
3. Optical Specifications	10
4. I/O Terminal	18
5. Test	20
6. Appearance Standards	21
7. Code System of Production Lot	24
8. Type Number	24
9. Applying Precautions	24
10. Precautions Relating Product Handling	25
11 Warranty	26

Revision History

Rev	Revision history				
Rev.	Date	Page	Comment		
T-	51991GD015-MLW-AIN (A	l) No. 2005-040	1 OPTREX CORPORATION Page 1/26		

1.General Specifications

Operating Temp. : min. -10°C ~max. 60°C

Storage Temp. : min. -30°C ~max. 70°C

Dot Pixels : 176 × 3 [R.G.B] (W) × 132 (H) dots

Dot Size : 0.056 (W) × 0.168 (H) mm

Pixel Arrangement : RGB-Stripe

Color Depth : Degital 64k color

Viewing Area : 31.92 (W) × 24.528 (H) mm

Outline Dimensions* : 35.47 (W) × 33.18* (H) × 2.35** (D) mm

* Without FPC **Without Hook

Weight : 5.5g max.

LCD Type : ASS-23211

(TFT / Normally white-mode / Transflective)

Viewing Angle : 4:30

TFT Driver : Controler driver R61506(RENESAS)

Data Transfer : 8-bit parallel data transfer

Backlight : LED Backlight / White

Drawings : Dimensional Outline T-51991Al base

Lead free : Our product corresponds to lead free.

Lead free is defined as below: The solder used in the LCD module.

Electrical components (Terminal section) used in the LCD module.

Any lead used within the electrical component does not apply to

our module definition of lead free.

T-51991GD015-MLW-AIN (AI) No. 2005-0401

OPTREX CORPORATION

Page 2/26

2. Electrical Specifications

2.1. Absolute Maximum Ratings

Parameter	Symbol	Conditions	Ratings	Units
LCD Supply Voltage	Vdd	-	-0.3 ~ +4.0	V
Logic I/O Voltage	VEE	-	-0.3 ~ +4.0	V
Logic Input Voltage	Vin	-	-0.3 < VDI < VEE + 0.3	V

2.2.DC Characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
LCD Supply Voltage	V _{DD} -V _{SS}	-	2.8	3.0	3.2	V
Logic I/O Voltage	VEE-VSS	-	2.7	3.3	3.6	٧
LED Inout Current	ILED	-	-	20	-	mA
"H" Level Input Voltage	Vıн	-	0.8 VEE	-	-	٧
"L" Level Input Voltage	VIL	-	-	-	0.2VEE	٧
"H" Level Outout Voltage	Vон	-	0.8 VEE	-	-	٧
"L" Level Output Voltage	Vol	-	-	-	0.2VEE	V
Power Consumption,Panel	PLCD	-	-	3.1	4.5	mW
Power Consumption,BacklightI	Рв	-	-	144	168	mW
Power Consumption, Standby	Ps	-	-	-	30	μW

Note

- 1:The specified current and power consumption are under the conditions at VDD=3.0V, VEE=3.3V, Ta=25°C, and fv=60Hz, 32 vertical stripe grayscale pattern is displayed and fv is the frame frequency. 2:Input mode of $D0\sim D7$, RES, RS, RD, WR, CS
- 3: Output mode of D0~D7,FLM
- 4:LED Backlight assumptions typ.3.6V and max. 4.2V, 20mA, 2LED's
- 5:VEE & VDD are present; RES,RD,WR,CS are high;

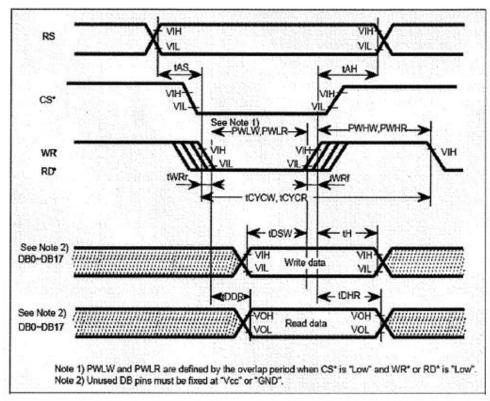
T-51991GD015-MLW-AIN (AI) No. 2005-0401	OPTREX CORPORATION	Page 3/26
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2.3. AC Characteristics

2.3.1. Timing Characteristics

Paran	neter		Symbol	Min.	Max.	Units
D. O. da Tina		Write	tcycw	140	-	ns
Bus Cycle Time		Read	t _{CYCR}	500		ns
Write "Low" Level Pulse	e Width	Write	Pwlw	60	-	ns
Read "Low" Level Pulse	e Width	Read	Pwlr	250	-	ns
Write "High" Level Puls	e Width	Write	Рwнw	100	-	ns
Read "High" Level Puls	e Width	Read	Pwhr	200	-	ns
Write / Read rise/fall til	me		t_{WR_f} , t_{WR_f}	-	25	ns
Out of Trans	Write(RS	~CS,WR)	+	50	-	ns
Setup Time	Read(RS	-CS,RD)	t as	50		ns
Address Hold Time			t ah	2	-	ns
Write Data Setup Time			t _{DSW}	60	-	ns
Write Data Hold Time			t _H	15	-	ns
Read Data Delay Time			t _{DDR}	-	80	ns
Read Data Hold Time			t _{DHR}	5	-	ns
Time from Read Cycle to Write				300	-	ns
Time from Write Cycle	to Read			300	-	ns

Note: $V_{DD}=2.80\sim3.20V$, $V_{EE}=2.70\sim3.60V$

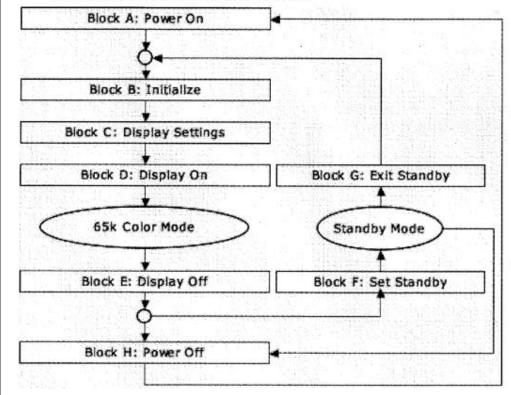


T-51991GD015-MLW-AIN (AI) No. 2005-0401 OPTREX CORPORATION

Page 4/26

2.3.2. Software Flow & Register Settings

The M26 displays with the R61506 driver follow the basic software flowchart illustrated in Figure 3-3. Each display supplier will have specific register settings for each block, as shown in 3.7.2 and 3.7.3.



2.3.3. Block A: Power On Sequence

Step	Register	Setting	Operation		
1		F	RESET=L		
2	Delay 1msec				
3	RESET=H				
4		Delay 2msec			

2.3.4. Block B: Initiaize Sequence

Step	Register	Setting	Operation
1	R00h	-	
2	R00h	-	
3	R00h		
4	R00h		
5	R00h	h 0001h Start Oscillation	
6	Delay 10msec		

2.3.5. Block C: Display Settings Sequence

Step	Register	Setting	Operation	
1	R07h	0001h	REV=0, D=01; Display Control (1)	
2	R17h	0001h	PSE=1; Power Sequence Control (1)	
3	R10h	24C0h	SAP=010, BT=100, APE=1, AP=100, DK=0 ; Power Control (1)	
4	R11h	0001h	DC1=000, DC0=000, VC=01; Power Control (2)	
5	R12h	001Ah	PON=1, VRH=1010; Set VREG1 Voltage	
6	R13h	0828h	VDV=1000, VCM=101000 ; Set VCOM Voltage	
7	R12h	003Ah	PSON=1; Start Charge pumps	
8		D	elay 150msec	
9	R01h	0110h	SM=0, GS=0, SS=1, NL=1000; Set Display Direction	
10	R03h	1030h	BGR=1, ID=11, AM=0 ; Set CF arrangement	
11	R08h	0404h	FP=0100, BP=0100; Set front/back porch	
12	R0Bh	000Ah	N0=00, SDT=00, DIV=00, RTN=1010; Set Frame Freq	
13	R0Dh	5559h	CAW=1001, CBW=0101, CCW=0101, CDW=0101; Set waveform timing	
14	R15h	0000h	VSEL=00 ; Set waveform timing	
15	R30h	0000h	PKP0=000, PKP1=000 ; Set Gamma	
16	R31h	0000h	PKP2=000, PKP3=000; Set Gamma	
17	R32h	0303h	PKP4=011, PKP5=011; Set Gamma	
18	R33h	0100h	PRP0=000, PRP1=001; Set Gamma	
19	R34h	0404h	PKN0=100, PKN1=100; Set Gamma	
20	R35h	0707h	PKN2=111, PKN3=111; Set Gamma	
21	R36h	0707h	PKN4=111, PKN5=111; Set Gamma	
22	R37h	0001h	PRN0=001, PRN1=000 ; Set Gamma	
23	R38h	1F04h	VRP0=0100, VRP1=11111; Set Gamma	
24	R39h	040Fh	VRN0=1111, VRN1=00100 ; Set Gamma	

T-51991GD015-MLW-AIN (AI) No. 2005-0401	OPTREX CORPORATION	Page 6/26
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25	R40h	0000h	SCN=0000 ; Set gate scan position		
26	R41h	0000h	VL=000000000; Set vertical scroll		
27	R42h	8300h	SE=10000011, SS=00000000 ; Set 1 st screen driving position		
28	R44h	AF00h	HEA=10100000, HAS=000000000; Set Window address (Horizontal)		
29	R45h	8300h VEA=10000011, VSA=0000000 window address (Vertical			
30	R21h	AD-000000000000000000000000000000000000			
31	R22h	3.5	Select RAM access Register		
32	Write CGRAM (repeat 176x132 times)				

2.3.6.Block D : Display On Sequence

Step	Register	Setting	Operation			
1	R02h	0600h	FLD=01, B/C=0			
2	R07h	0021h	VON=0, GON=1, DTE=0, D=01; Display Control (1)			
3		De	elay 1msec			
4	R07h	0072h	VON=1; Display Control (1)			
5		Del	ay 100msec			
6	R02h	0700h	FLD=01, B/C=1; Set LCD driving waveform			
7	R07h	0077h	REV=1, D=11; Display Control (1)			
	3900 (900	65K	Color Mode			

2.3.7.Block E : Display Off Sequence

Step	Register	Setting	Operation		
1	R07h	0072h	REV=0, D=10; Display Control (1)		
2		De	lay 40msec		
3	R07h	0001h	VON=0, GON=0, DTE=0, D=01; Display Control (1)		
4		De	elay 1msec		
5	R07h	0000h	D=00 ; Display Control (1)		

T-51991GD015-MLW-AIN (AI) No. 2005-0401	OPTREX CORPORATION	Page 7/26
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2.3.8.Block F : Power Off Sequence

Step	Register	Setting	Operation		
1	R10h	0480h	SAP=000, AP=000; Stop Op-Amps		
2	R12h	0000h	PSON=0, PON=0 ; Stop Charge Pump		
3		D	elay 20msec		
4	R10h	0400h	APE=0 ; Stop Power Circuit		

2.3.9. Block G: Set Standby Sequence

Step	Register	Setting	Operation
1	R10h	24C1h	STB=1; Set Standby
2	war en	Stand	by Mode

2.3.10.Block H: Exit Standby Sequence

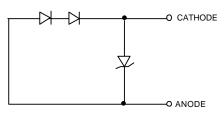
Step	Register	Setting	Operation
1	None		Exit Sequence is same as Table 2, Table 3, and Table 4
2			Delay

3.Backlight Specifications

3.1. Absolute Maximum Ratings (2 chip)

Ta=25°C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Current	lF	-	-	-	30	mA
Reverse Voltage	VR	-	-	-	10.0	V
LED Power Dissipation	PD	-	-	-	240	mW



3.2. Operating Characteristics

Ta=25°C

Page 9/26

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Voltage	VF	I=20mA	5.2	6.4	7.0	V

4.Optical Specifications

4.1.Backlight Off

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remark
	θ_{LEFT}		35	-	-	° (degree)	Note1,2,3
Nr. Comments and	$\theta_{\sf UP}$	00.0	35	-	-	° (degree)	Note1,2,3
Viewing angle range	θ_{RIGHT}	CR≥2	35	ı	-	° (degree)	Note1,2,3
	θ_{DOWN}		35	ı	-	° (degree)	Note1,2,3
Contrast Ratio	CR	Optimal	10	-	-	-	Note1,2,6
Reflectivity	R	Optimal	5.5	-	-	%	Note1,4,6
Response Rise Time	τr	θ=0°	-	10	15	ms	Note1,5,7
Response Fall Time	τd	Ta=25°C	-	20	30	ms	Note1,5,7
	Х	CIE	0.292	0.312	0.332	-	Note1,6
White Chromaticity	Y		0.311	0.331	0.351	-	Note1,6
5 10	Х	O.F.	0.418	0.438	0.458	-	Note1,6
Red Chromaticity	Y	CIE	0.297	0.327	0.357	-	Note1,6
	Х	0.5	0.285	0.305	0.325	-	Note1,6
Green Chromaticity	Υ	CIE	0.369	0.389	0.409	-	Note1,6
	Х	O.F.	0.199	0.219	0.239	-	Note1,6
Blue Chromaticity	Y	CIE	0.219	0.239	0.259	-	Note1,6

Note 1 :The testing conditions are illustrated in Figure 4-1 and taken at Ta=25°C in a dark room with a D65 light source. The display is oriented landscape with the driver on the right. The photodetector is CS-1000.

Note 2: The definition of contrast ratio is shown in Section 4.2.1

Note 3: The definition of viewing angle is shown in Section 4.2.2

Note 4: The definition of reflectivity is shown in Section 4.2.3

Note 5: The definition of response time is shown in Section 4.2.4

Note 6: Critical optical characteristics.

Note 7: The measuring equipment are TOPCON BM-7

T-51991GD015-MLW-AIN (AI) No. 2005-0401	OPTREX CORPORATION	Page 10/26
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4.2. Backlight On

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Remark
	θ_{LEFT}		35	40	-	Degrees	Note1,2,3
Viewing angle renge	$\theta_{\sf UP}$	CR≥5	30	35	-	Degrees	Note1,2,3
Viewing angle range	θ_{RIGHT}	UK≥o	30	35	-	Degrees	Note1,2,3
	θ_{DOWN}		20	25	-	Degrees	Note1,2,3
Contrast Ratio	CR	Optimal	70	80	-	-	Note2,6,13
Brightness	Υ	Optimal	120	150	-	cd/m ²	Note6,12,13
Brightness Uniformity	Υ	Optimal	-	-	20	%	Note5,12,13
Gamma				2.2			Note7
Flicker	F		-	-	-30	dB	Note8
Cross Talk	D _{SHA}	Optimal			4	%	Note9
Viewing Direction				4:30		o'clock	Note10
Response Rise Time	τr	θ =0°	-	15	20	ms	Note5,13
Response Fall Time	τd	Ta=25°C	-	25	35	ms	Note5,13
NA/Ibita Olamamatiaitu	Х	OIE		0.305		-	Note6,11,13
White Chromaticity	Υ	CIE		0.335		-	Note6,11,13
D. I Ol	Х	OIE		0.531		-	Note6,11,13
Red Chromaticity	Υ	CIE		0.335		-	Note6,11,13
One on Observation	Х	OIF		0.329		-	Note6,11,13
Green Chromaticity	Υ	CIE		0.530		-	Note6,11,13
División Chromostinito	Х	OIF.		0.158		-	Note6,11,13
Blue Chromaticity	Υ	CIE		0.153		-	Note6,11,13

- Note 1 :The testing conditions are illustrated in Figure 4-2 and taken at Ta=25°C in a dark room using ELDIM EZ contrast 160R system. The display is oriented landscape with the driver on the right.
- Note 2: The definition of contrast ratio is shown in Section 4.2.1
- Note 3: The definition of viewing angle is shown in Section 4.2.2
- Note 4: The definition of response time is shown in Section 4.2.4
- Note 5: The definition of brightness & brightness uniformity is shown in Section 4.2.5.
- Note 6: Critical optical characteristics.
- Note 7: The gray scale linearity or gamma value is specified in Section 4.3.
- Note 8: The flicker level is specified in Section 4.4.
- Note 9: The cross talk is specified in Section 4.5.
- Note 10 : The viewing / rubbing direction is the direction of least color inversion.
- Note 11: The color coordinate tolerance is plotted in Section 4.6.
- Note 12: Brightness may also be referred to as luminance.
- Note 13: The measuring equipment are TOPCON BM-7.

T-51991GD015-MLW-AIN (AI) No. 2005-0401	OPTREX CORPORATION	Page 11/26
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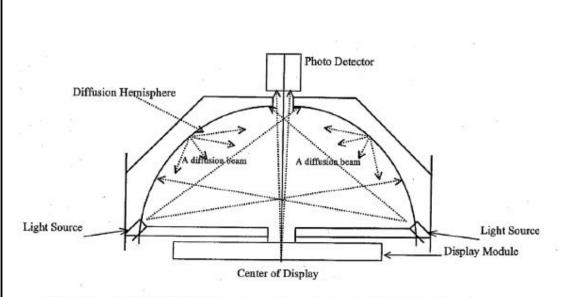


Figure 4-1: Optical Test Setup - Backlight Off (D65 Light Source)

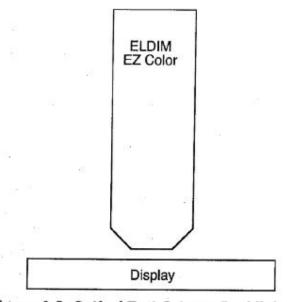


Figure 4-2: Optical Test Setup - Backlight On

T-51991GD015-MLW-AIN (AI) No. 2005-0401 OPTREX CORPORATION Page 12/26

4.2. Optical Definitions

4.2.1. Definition of Contrast Ratio

4.2.2. Definition of Viewing Angles

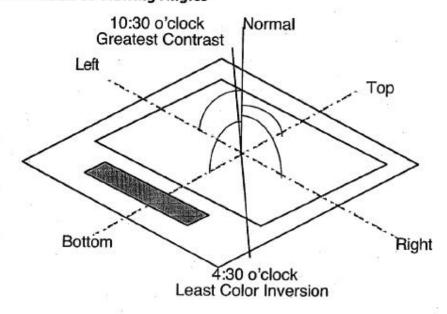


Figure 4-3: Viewing Angle Definitions

4.2.3. Definition of Reflectivity

The reflectivity measurement is taken using the set-up in Figure 4-1.

T-51991GD015-MLW-AIN (AI) No. 2005-0401

OPTREX CORPORATION

Page 13/26

4.2.4. Definition of Response Time

Figure 4-4 shows the response time characteristics for the display. Rise Time (τ_r) is the time required for the luminance level or reflectivity to reach 10% of minimum from 90% brightness or reflectivity respectfully, when the display is switched from an all-white to an all-black screen. Decay Time (τ_d) is the time required for the luminance level or reflectivity to reach 90% brightness or reflectivity respectfully from 10%, when the display is switched from an all-black to an all-white screen.

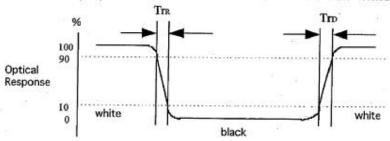


Figure 4-4: Response Time Definition

4.2.5. Definition of Brightness & Brightness Uniformity

The brightness measurement is taken at point B5.

Brightness
Uniformity = 1 — Maximum Photo detector output for B1-B9 with all pixels white

Maximum Photo detector output for B1-B9 with all pixels white

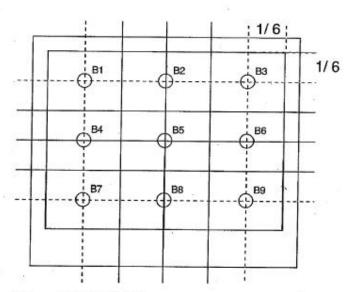


Figure 4-5: Brightness measurement points

T-51991GD015-MLW-AIN (AI) No. 2005-0401

OPTREX CORPORATION

Page 14/26

4.3. Gray Scale Linearity or Gamma Value

The display luminance, L_G , is measured at the different gray scales, G_{min} , ..., G_{mex} . The exponential fitting is used to determine the gamma () value, which should be an intrinsic or uncorrected characteristic.

$$L_G \sim G$$
 .

4.4. Flicker

NO VISUAL FLICKER WILL BE ALLOWED. The flicker level should be measured with horizontal stripes (every other pixel), a checker pattern (every other pixel) and a middle gray level. The frame frequency of the panel should be set to 60Hz and V_{DD} is set to 3.0 V. The output signal of a photometer is sent to an FFT analyzer. The flicker is essentially a ratio of the powers in the frequency spectrum at 30 Hz (P_x) and 0 Hz (P_0), i.e., θ

$$F = 10 \text{ Log } (P_x / P_0).$$

4.5. Cross-talk

The following measurement method for cross-talk is to be used during the development and initial qualification of the display design. Apple approved visual test patterns and limit samples may be used in production along with limit samples measured at or below the maximum of the specification. Two luminance values are measured at center spot with 50×50 pixels. The cross-talk, D_{SHA} , is defined as,

 $D_{SHA} = (L_B - L_A)/L_B \bullet 100\%,$ Where, $L_A =$ Luminance in Pattern A $L_B =$ Luminance in Pattern B.

Pattern A



Pattern A Gray Scale = 31 in center Black in surrounding area

Pattern B



Pattern B Gray Scale = 31 full screen

4.6. White Chromaticity Area

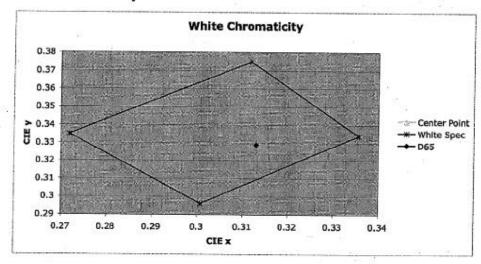


Figure 4-6: Transmissive White Chromaticity Area

Table 4.6.1: Transmissive White Chromaticity Data Points

X	Υ
0.301	0.296
0.272	0.335
0.312	0.375
0.336	0.334

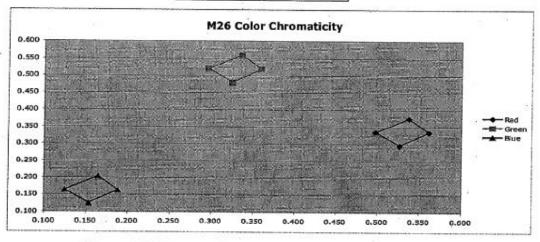


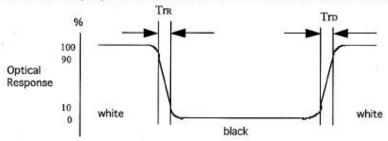
Figure 4-7: Transmissive Color Chromaticity Area

T-51991GD015-MLW-AIN (AI) No. 2005-0401

OPTREX CORPORATION

Page 16/26

Figure 4-4 shows the response time characteristics for the display. Rise Time (τ_r) is the time required for the luminance level or reflectivity to reach 10% of minimum from 90% brightness or reflectivity respectfully, when the display is switched from an all-white to an all-black screen. Decay Time (τ_d) is the time required for the luminance level or reflectivity to reach 90% brightness or reflectivity respectfully from 10%, when the display is switched from an all-black to an all-white screen.



T-51991GD015-MLW-AIN (AI) No. 2005-0401

OPTREX CORPORATION

Page 17/26

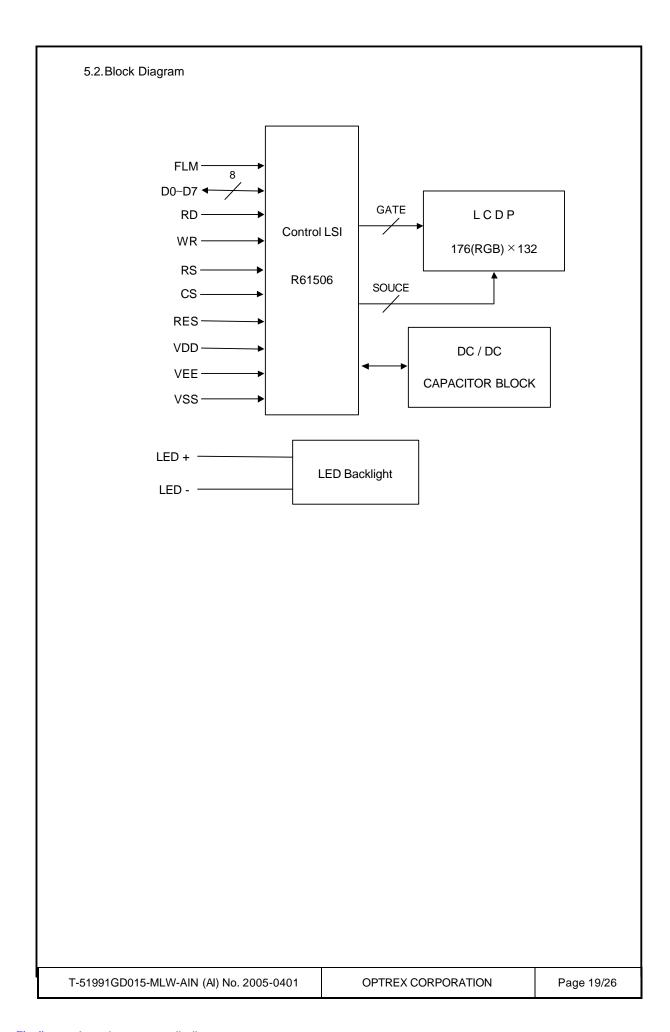
5.I/O Terminal

5.1.Pin Assignment

CN1

No.	Symbol	I/O	Function
1	LED+	-	LED Anode
2	LED-	-	LED Cathode
3	FLM	0	First Line Marker(Indicates Start of Frame)
4	VSS	-	GND
5	D7	I/O	Data Bus(8-bit MSB)
6	D6	I/O	Data Bus
7	D5	I/O	Data Bus
8	D4	I/O	Data Bus
9	D3	I/O	Data Bus
10	D2	I/O	Data Bus
11	D1	I/O	Data Bus
12	D0	I/O	Data Bus(LSB)
13	RD	ı	Read Control Input L:Active
14	WR	ı	Write Control Input L:Active
15	RS	ı	Reister Select Input
16	CS	ı	Chip Select Input L:Active
17	RES	ı	Reset Signal Input L:Active
18	VSS	-	GND
19	VEE	-	Logic I/O Supply
20	VDD	-	LCD Power Supply
21	Display ID	-	Display Version (No Conection)
22	Display ID	-	Display Version (No Conection)

T-51991GD015-MLW-AIN (AI) No. 2005-0401	OPTREX CORPORATION	Page 18/26
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6.Test

No change on display and in operation under the following test condition.

Conditions: Unless otherwise specified, tests will be conducted under the following condition.

Temperature: 20±5°C Humidity: 65±5%RH

tests will be not conducted under functioning state.

No.	Parameter	Conditions	Notes
1	High Temperature Operating	50°C, 500hrs (operation state)	
2	Low Temperature Operating	-10°C, 500hrs (operation state)	1
3	High Temperature Storage	70°C, 500hrs	2
4	Low Temperature Storage	-30°C, 500hrs	1,2
5	Damp Proof Test Operating	50°C, 90%RH, 240hrs	
6	Damp Proof Test Storage	70°C, 85%RH, 500hrs	
7	Thermal Shock Test	-30°C (30min) ↔ 70°C (30min) 100 cycles	
8	Shock Test	To be measured after dropping from 60cm high on the concrete surface in packing state. Dropping method corner dropping A corner: once Edge dropping B,C,D edge: once Face dropping E,F,G face: once	

Note 1: No dew condensation to be observed.

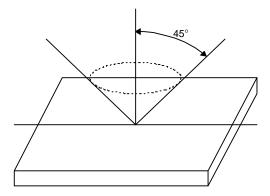
Note 2 :The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after removed from the test chamber.

Note 3: Vibration test will be conducted to the product itself without putting it in a container.

7.Appearance Standards

7.1. Viewing distance and angle

The distance between the eyes and the sample shall be 35±5cm. All directions for inspecting the sample should be within 45° against perpendicular line.



7.2. Ambient illumination

2000-3000 Lux at the surface of the LCM panel for reflective mode. The ambient is 100-150 Lux when backlight is on.

7.3. Ambient temperature

20-25°C

T-51991GD015-MLW-AIN (AI) No. 2005-0401

OPTREX CORPORATION

Page 21/26

7.4. Standards

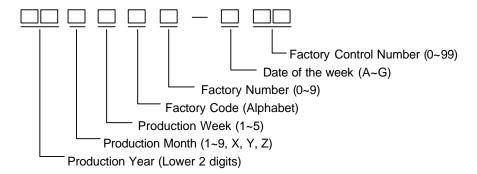
No.	Parameter	Criteria				
1	Bright and	l				
	Black Dot	A	Acceptable Num	ber	Testing Pattern	
		Bright Dot (0	8/64 gray level pattern	
		Dark Dot	2)*	White pattern	
		Joined	1 Pair MAX			
		Dark Dot	Dark Dot (1 pair : 1 black dot count). The two defective dots are allowed to be side by side,			
					White pattern	
					vville pattern	
			but not head t	to tail.		
			3 dots or more	e is not allowed		
		*Defect dista	nce 5mm or mo	ore		
2	Dark / Bright Spot	(1) Dark / Bri	ght Spot			
	(foreign substance)	Dimension	Dimension (mm)		table Number	
	Bright Line(light lint) /		0 ≤ 0.15	D	Disregard	
	Dark Line	0.15 < 🛚	0.15 < D ≤ 0.3		2	
	(dark lint / hair)	0.3 < [0.3 < D		0	
	Polarizer Scratches	D = (Long + Short) / 2				
	Polarizer Dent,					
	Bubbles	(2) Bright Lin	e / Dark Line			
		X(mm)	Y(mm)	Accept	table Number	
		-	W<0.02	D	isregard	
		L≤2.0	0.02≤W≤0.15		2	
		X : Lengtl	n Y: Width			
		(3) Polarizer	Scratches			
		W≤0.05mm	n, L≤2.0mm, N≤2	2		
		(4) Polarizer	Dent, Bubbles			
			O ≤ 0.3mm, N≤3	3		
		Maximum allo	owable number	of visual defects	s are eights.	

T-51991GD015-MLW-AIN (AI) No. 2005-0401	OPTREX CORPORATION	Page 22/26
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No.	Parameter		Criteria		
3	Polarizer Dirts	If the stains are removed not defective.	If the stains are removed easily from LCDP surface, the module is not defective.		
4	Chipped Glass			1100	
		Items	Inspection criteria (Acceptable level)	note	
		Chip on glass corner (Part A)	L <= 5mm, D <= 1mm L + D <= 5mm *BM (black mask) is not affected.	fig.1- A fig.2	
		Chip on the terminal glass(Part B)	L <= 3mm , D <= 3mm *FPC and patterns are not affected	fig.1-B fig.2	
		Chip on glass edge	L <= 10mm , D <= 1mm *BM (black mask) is not affected	fig.3	
		Chip To deliver the second of		ing side lort side	
		L			

8.Code System of Production Lot

The production lot of module is specified as follows.



9.Type Number

The type number of module is specified as follows.

T-51991AI

10.Applying Precautions

Please contact us when questions and/or new problems not specified in this Specifications arise.

T-51991GD015-MLW-AIN (AI) No. 2005-0401

OPTREX CORPORATION

Page 24/26

11.Precautions Relating Product Handling

The Following precautions will guide you in handling our product correctly.

- 1) Liquid crystal display devices
- The liquid crystal display device panel used in the liquid crystal display module is made of plate glass. Avoid any strong mechanical shock. Should the glass break handle it with care.
- 2. The polarizer adhering to the surface of the LCD is made of a soft material. Guard against scratching it.
- 2) Care of the liquid crystal display module against static electricity discharge.
 - 1. When working with the module, be sure to ground your body and any electrical equipment you may be using. We strongly recommend the use of anti static mats (made of rubber), to protect work tables against the hazards of electrical shock.
- 2. Avoid the use of work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.
- 3. Slowly and carefully remove the protective film from the LCD module, since this operation can generate static electricity.
- 3) When the LCD module alone must be stored for long periods of time:
 - 1. Protect the modules from high temperature and humidity.
- 2. Keep the modules out of direct sunlight or direct exposure to ultraviolet rays.
- 3. Protect the modules from excessive external forces.
- 4) Use the module with a power supply that is equipped with an overcurrent protector circuit, since the module is not provided with this protective feature.
- 5) Do not ingest the LCD fluid itself should it leak out of a damaged LCD module. Should hands or clothing come in contact with LCD fluid, wash immediately with soap.
- 6) Conductivity is not guaranteed for models that use metal holders where solder connections between the metal holder and the PCB are not used. Please contact us to discuss appropriate ways to assure conductivity.
- 7) For models which use CFL:
- 1. High voltage of 1000V or greater is applied to the CFL cable connector area. Care should be taken not to touch connection areas to avoid burns.
- 2. Protect CFL cables from rubbing against the unit and thus causing the wire jacket to become worn.
- The use of CFLs for extended periods of time at low temperatures will significantly shorten their service life.
- 8) For models which use touch panels:
 - Do not stack up modules since they can be damaged by components on neighboring modules.
 - 2. Do not place heavy objects on top of the product. This could cause glass breakage.
- 9) For models which use COG, TAB, or COF:
- 1. The mechanical strength of the product is low since the IC chip faces out unprotected from the rear. Be sure to protect the rear of the IC chip from external forces.
- 2. Given the fact that the rear of the IC chip is left exposed, in order to protect the unit from electrical damage, avoid installation configurations in which the rear of the IC chip runs the risk of making any electrical contact.

T-51991GD015-MLW-AIN (AI) No. 2005-0401 OPTREX CORPORATION Page 25/26

- 10) Models which use flexible cable, heat seal, or TAB:
- 1. In order to maintain reliability, do not touch or hold by the connector area.
- Avoid any bending, pulling, or other excessive force, which can result in broken connections.
- 11)In case of buffer material such as cushion / gasket is assembled into LCD module, it may have an adverse effect on connecting parts (LCD panel-TCP / HEAT SEAL / FPC / etc., PCB-TCP / HEAT SEAL / FPC etc., TCP-HEAT SEAL, TCP-FPC, HEAT SEAL-FPC, etc.,) depending on its materials.

Please check and evaluate these materials carefully before use.

12) In case of acrylic plate is attached to front side of LCD panel, cloudiness (very small cracks) can occur on acrylic plate, being influenced by some components generated from polarizer film..

Please check and evaluate those acrylic materials carefully before use.

12.Warranty

This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- 2. We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- We cannot accept responsibility for any defect, which may arise due to the application of static electricity after the product has passed your company's acceptance inspection procedures.
- 4. When the product is in CFL models, CFL service life and brightness will vary According to the performance of the inverter used, leaks, etc. We cannot accept responsibility for product performance, reliability, or defect, which may arise.
- 5. We cannot accept responsibility for intellectual property of a third party, which may arise through the application of our product to your assembly with exception to those issues relating directly to the structure or method of manufacturing of our product.
- 6. Optrex will not be held responsible for any quality guarantee issue for defect products judged as Optrex-origin longer than 2 (two) years from Optrex production or 1(one) year from Optrex, Optrex America, Optrex Europe delivery which ever comes later.

T-51991GD015-MLW-AIN (AI) No. 2005-0401

OPTREX CORPORATION

Page 26/26